	BLE STAN				ST	ORAGE							
	TEMPERATURE RANGE		-55 °C TO 85 °C (1)			TEMPERATURE RANGE			-10 °C TO 60 °C				
RATING	VOLTAGE		100 V AC	100 V AC RA			ORAGE HUMIDITY ANGE PERATING HUMIDITY			40 % TO 70 % (2)			
	CURRENT					ANGE RELATIVE HUMI				VE HUMIDITY	TY 85 % max		
	CORREINT		3 A (MF CONTACT)					(NOT DEWED)					
			SPEC	IFICA	TION	S							
	EM		TEST METHOD				RE	QUIR	EMENTS	6	QT	A	
CONSTRU													
GENERAL E MARKING	XAMINATION		Y AND BY MEASURING IN MED VISUALLY.	ISTRUM	ENT.	ACCO	RDING T	O DRA	WING.		×	×	
	CHARAC										^	^	
) mA(DC OR 1000Hz)			SIGNA	L CONT	ACT :	90 m Ω	MAX	×	- 1	
			· · · · · ·				NTACT	:					
INSULATION RESISTANCE						1000 MΩ MIN.						_	
VOLTAGE PROOF		300 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.						-	
	CAL CHAR										×	1	
INSERTION AND WITHDRAWAL FORCES		MEASURED BY APPLICABLE CONNECTOR.			‹ .	INSERTION FORCE: 70 N MAX. WITHDRAWAL FORCE: 7 N MIN.						_	
MECHANICAL		500 TIMES INSERTIONS AND EXTRACTION			NS.	(1) CONTACT RESISTANCE:					×	_	
OPERATION						SIGNAL CONTACT : 100 m Ω MAX.							
						MF	F CONTACT : $40 \text{ m} \Omega \text{ MAX}.$					1	
						② NO DAMAGE, CRACK AND LOOSENES							
VIBRATION		FREQUENCY 10 TO 55 TO 10Hz, APPROX 5m				OF PARTS. ① NO ELECTRICAL DISCONTINUITY OF ×						_	
VIDICATION		SINGLE AMPLITUDE : 0.75 mm, 10 CYCLES				1 µs.							
			DIRECTIONS.			•		E, CRA	CK AND L	OOSENESS			
SHOCK		490 m/s ² , DURATION OF PULSE 11 ms				OF PARTS.					×	-	
			TIMES FOR 3 DIREC	TIONS.									
DAMP HEAT				<u>) 5 9/ 0</u>	ne h		NTACT F	DEGIGT			×	_	
(STEADY ST		EXPOSED AT 40 ± 2 °C, $90 \sim 95$ %, 96 h.			ю п.	~			: 100 m	2 MAX.	Â		
RAPID CHAN	NGE OF	TEMPER	TEMPERATURE -55 → +85 °C			MF CONTACT : 40 m Ω MAX.						_	
TEMPERATURE		TIME 30 \rightarrow 30 min. UNDER 5 CYCLES.				② INS	ULATIO	N RES	STANCE				
						@ NO	D			$M\Omega$ MIN.			
		(RELOCATION TIME TO CHAMBER:WITHIN 2~3 MIN)				③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.							
SULFUR DIOXIDE		EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR				NO HEAVY CORROSION.					×	-	
		96 h.											
REGIGTANO	E TO		ANDARD: JIS C 60068)							F		<u> </u>	
RESISTANCE TO SOLDERING HEAT		1)REFLOW SOLDERING : PEAK TMP : 260°CMAX				NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE					×	-	
		REFLOW TMP: 220°CMIN FOR 60sec				TERMINAL.						ĺ	
		,	RING IRONS : 360°C MAX		sec.								
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.									×	-	
					ec.	SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.							
											+	-	
												1	
COUN	D	ESCRIPTI	ON OF REVISIONS		DESIG	SNED			CHECKE	D	DA	TE	
<u>A</u>													
REMARKS ⁽¹⁾ INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING.						APPROVED			HS. OKAWA		15.0	15.06.30	
		EANS A LONG-TERM STORAGE STATE SED PRODUCT BEFORE ASSEMBLY TO PCB. JRRENT APPLIES TO PER CONTACT.					CHEC	KED	HT. YAMAGUCHI			6.30	
	⁽³⁾ THE RATED C				o			NED	TH. SANO		15.0	6.30	
l Inless oth			EN ALL THE CONTACTS ARE USED FOR CURRENT CARRY ed. refer to .JIS-C-5402.			ING. DRAWN			TH. S	ANO	15.06.3		
Unless otherwise specified, refer to JIS-C-5402. Note QT:Qualification Test AT:Assurance Test X:Applicable Test					יח	DRAWING NO. ELC-3493							
					PART NO.			FX18-120PS-0. 8H15				•	
HRS												4 / 4	
		OSE ELECTRIC CO., LTD.			CODE NO.		CL579-0053-6-00				/0\	1/1	
EORM HDOO11.	0 1												